



Winbond Electronics Corporation

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Hsinchu County 30274, Taiwan R.O.C.

Product Obsolescence Notice

W25Q128JW SpiFlash Memories

Notification Date: Dec,16, 2019

Dear Valued Customer,

This letter is to notify you of Winbond’s intention to terminate production of the W25Q128FW SpiFlash memory, and replace it with the W25Q128JW. Replacement part numbers are listed below:

Winbond Current PN (58nm F-Series)	Winbond Primary Replacement PN (58nm J-Series)
W25Q128FWYIC	W25Q128JWYIQ W25Q128JWYIM
W25Q128FWSIG W25Q128FWSIQ W25Q128FWSIF	W25Q128JWSIQ W25Q128JWSIM
W25Q128FWEIG W25Q128FWEIQ	W25Q128JWEIQ W25Q128JWEIM
W25Q128FWPIG W25Q128FWPIQ W25Q128FWPIF	W25Q128JWPIQ W25Q128JWPIM
W25Q128FWBIG W25Q128FWBIQ	W25Q128JWB IQ W25Q128JWBIM

For WLCSP, please contact our sales to get the different POD Dimension.

The W25Q128JW device features:

Features

- a) Command backward compatible with W25Q128FW (same Superset Instruction Set)
- b) Clock operation up to 133MHz
- c) Support DTR with Max. frequency up to 66MHz
- d) SPI with Single / Dual / Quad / QPI
- e) Flexible architecture with 4KB sectors
- f) Support low power consumption compared to W25Q128FW
- g) Support fast programing compared to W25Q128FW

Please refer to the table below for your particular product last time order date and Winbond last shipment date and use this table to determine your last time buys and subsequent request dates. Winbond Electronics reserves the right to limit last time buy quantities based on capacity and material availability. Please notify Winbond as soon as possible if there are any concerns with these this schedule.

Part Number	Notification Date	Last Order Date	Last Ship Date	Part Number	Reliability Report	Mass Production
W25Q128FW	Jan./01/ 2020	Jul./01/ 2020	Jan./01/ 2021	W25Q128JW	ready	Sep./01/ 2019

Jooweon Park
Technology Executive
Flash Product Marketing Center